

## DSG-R&D EIC Meeting

**Date: October 21, 2021**

**Time: 11:00 – 12:00**

*Attendees: Aaron Brown, Peter Bonneau, Pablo Campero, Brian Eng, George Jacobs, Mindy Leffel, Tyler Lemon, Marc McMullen, and Amrit Yegneswaran*

### 1. EIC

#### 1.1. Reviewing current Ansys simulation status results

1.1.1. Stagnant air used for convection, i.e. no forced air cooling between any surfaces

1.1.2. 50 °C limit (from Leo Greiner) mainly due to adhesives used to assemble Si

Layers 1.1.3. Temperatures calculated at several Argon temperatures.

